PEC. NO.: PS-53	006-XXXX-XXX	REVISION: O
RODUCT NAME:	2.0mm BATTERY T/H TYP	PE CONN
-		
RODUCT NO:	53005-XXXX-XXX; 53006	S-XXXX-XXX
REPARED:	CHECKED:	APPROVED:
REPARED: HUANTY	CHECKED: TONY	APPROVED: JASON
HUANTY ATE:	TONY DATE:	JASON DATE:
HUANTY PATE:	TONY DATE:	JASON DATE:

			Aces P/N: 53006-XXXXX-XXX SERIES					
TITLE:	2.0mm BATTER	Y T/H TYPE (CONN					
RELEASE	DATE: 2012/06/08	REVISION: O		ECN No: 1206071	PAGE: 2 OF 9			
1 2 3 4 5 6 7	SCOPE APPLICABLE DO REQUIREMENTS PERFORMANCE INFRARED REF	DCUMENTS S LOW CONDI	 ГІОN	SEQUENCE				

Aces P/N: 53006-XXXXX-XXX SERIES

TITLE: 2.0mm BATTERY T/H TYPE CONN

REVISION: O

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1 Revision History

ECN #	Revision Description	Prepared	Date
ECN-1110218	NEW SPEC	HUANTY	2011/10/19
ECN-1206071	RELEASE	HUANTY	2012/6/8
		ECN-1110218 NEW SPEC	ECN-1110218 NEW SPEC HUANTY

		Ac	es P/N: 53006-X	XXXX-XXX SER	ES
Т	ITLE: 2.0mm BATTER	Y T/H TYPE CO	NN		
REL	EASE DATE: 2012/06/08	REVISION: O	ECN No:	1206071	PAGE: 4 OF 9
2	SCOPE This specification co Battery T/H TYPE C		e, tests and quali	ty requirements for :	2.0mm pitch
3	APPLICABLE DOC EIA-364: ELECTRONI REQUIREMENTS		ASSOCIATION		
	applicable 4.1.2 All materia 4.2 Materials and Finish 4.2.1 Contact: Hi Finish: 4.2.2 Housing: T 4.2.3 Fitting nail: Finish: 4.3 Ratings 4.3.1 Voltage: 30 4.3.2 Current: 5.0	nall be of design, c product drawing. als conform to R.o. gh performance co (a) Contact Area: F (b) Under plate: Ro (c) Solder area: Ro hermoplastic or Th High performance (a) Contact Area: F	H.S. and the stand opper alloy (Brass) Refer to the drawing efer to the drawing ermoplastic High T copper alloy Refer to the drawing efer to the drawing	g. ēemp., UL94V-0 g.	
			Page 4	2010/10/31	TR-FM-73015L

 Aces P/N: 53006-XXXXX-XXX SERIES

 TITLE:
 2.0mm BATTERY T/H TYPE CONN

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5 Performance

5.1. Test Requirements and Procedures Summary

ltem	Requirement	Standard				
	Product shall meet requirements of					
Examination of Product	applicable product drawing and	per applicable quality inspection				
	specification.	plan.				
	ELECTRICAL					
ltem	Requirement	Standard Mate connectors, measure by dry circuit, 20mV Max., 100mA Max.				
Low Level Contact Resistance	$30 \text{ m } \Omega$ Max.(initial)per contact 15 m Ω Max.(after test) Change allowed					
Insulation Resistance	500 M Ω Min.	(EIA-364-23) Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 m A max.	(EIA-364-21) 300V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)				
	MECHANICAL					
ltem	Requirement	Standard				
Durability	5000 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3 mm/min. (EIA-364-09) Operation Speed : 25.4 ± 3 mm/minute Measure the force required to mate/Un-mate connector. (EIA-364-13)				
Mating / Un-mating Forces	Mating Force: 0.25kgf Max / per pin. Un-mating Force: 0.02 kgf Min / per pin					
Contact Retention Force	0.4kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.				

	Aces I	P/N: 53006-XXX)	XX-XXX SE	RIES			
E: 2.0mm BATTER	Y T/H TYPE CONN	1					
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Item	Requi	rement	StandardOperation Speed :25.4 ± 3 mm/minute.Measure the contact retention forcewith Tensile strength tester.				
Fitting nail / Housing Retention Force	0.40kgf MIN.	25. Me					
Vibration Shock (Mechanical)	1 μ s Max. 1 μs Max.	be cor hai of (tota be Th 10 sha 1 n ap mu (EI Su 50 pul Th sha mu	The electrical load condition shall be 100 m A maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I) Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The				
		100 (EI	0mA maximum fo A-364-27, test co	or all contacts.			
		ONMENTAL	01				
Item Resistance to Reflow Soldering Heat		He	~120sec. at:230℃ Min., ak Temp.:260℃	180℃, 40sec Min.			
Thermal Shock	See Product Qua Sequence Group	alification and Test 1 c 4 -55 +89	Mate module and subject to follow condition for 10 cycles. Test 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)				
Humidity	See Product Qua Sequence Group	alification and Test 40	hours.				

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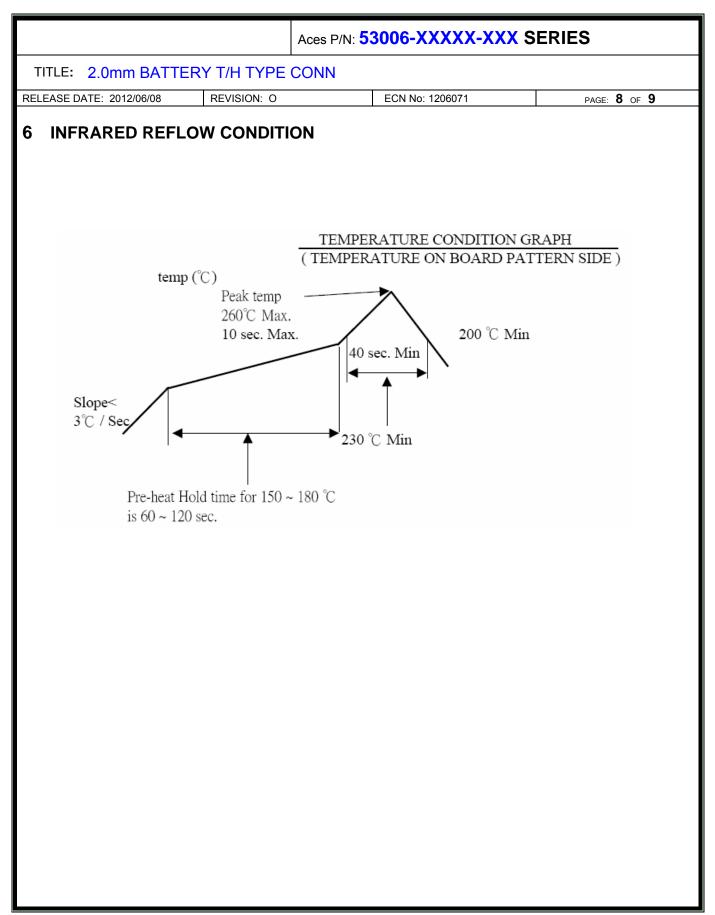
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ltem	Requirement	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)			
Temperature life	See Product Qualification and Test Sequence Group <mark>5</mark>				
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group <mark>6</mark>	Subject mated/unmated connectors to 5% salt-solution t concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)			
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)			
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.			

Note. Flowing Mixed Gas shell be conduct by customer request.



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RELEASE DATE: 2012/06/08 REVISION: 0	<u>о</u>			ECN No:	: 12060	71			PAGE	E: 9 of	9
7 PRODUCT QUALIFICATION	ANC) TES	T SE		NCE		_	_	_	_	_
		Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product				1 • 7	1、6	1、4			1	1	1
Low Level Contact Resistance		1、5	1、4	2、10	2、9	2、5			3	[
Insulation Resistance				3、9	3、8		!			[!	
Dielectric Withstanding Voltage				4 • 8	4 \ 7						
Temperature rise	1										
Mating / Unmating Forces		2 \ 4									
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Contact Retention Force								1			
Fitting Nail /Housing Retention Force								2			
Resistance to Soldering Heat									2		
Hand Soldering Temperature Resistance										2	
Sample Size	2	4	4	4	4	4	2	4	4	4	4